EFS ID:	1221273	
Application Number:	10585522	
Confirmation Number:	4528	
Title of Invention:	Process for producing soi wafer	
First Named Inventor:	Hiroji Aga	
Customer Number:	23581	
Filer:	Anton E. Skaugset	
Filer Authorized By:		
Attorney Docket Number:	SHX 367	
Receipt Date:	26-SEP-2006	
Filing Date:		
Time Stamp:	20:06:22	
Application Type:	U.S. National Stage under 35 USC 371	

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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		TRAN_SUB_SUPP_IDS_SH X367.pdf	143642	yes	4

	Multipart Description			
	Doc Desc	Start	End	
	Transmittal letter	1	1	
	Information Disclosure Statement (IDS) Filed	2	4	
Warnings:				
Information	:			

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143642

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## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.